

April 2015

# 74LCX157 Low Voltage Quad 2-Input Multiplexer with 5 V Tolerant Inputs

#### **Features**

- 5 V Tolerant Inputs
- 2.3 V 3.6 V, V<sub>CC</sub> Specifications Provided
- 5.8 ns  $t_{PD}$  max. ( $V_{CC} = 3.3 \text{ V}$ ), 10  $\mu$ A  $I_{CC}$  max.
- Power Down High Impedance Inputs and Outputs
- ±24 mA Output Drive (V<sub>CC</sub> = 3.0 V)
- · Implements Patented Noise/EMI Reduction Circuitry
- Latch-Up Performance Exceeds 500 mA
- ESD Performance:

Human Body Model > 2000 V Machine Model > 200 V

### **General Description**

The LCX157 is a high-speed quad 2-input multiplexer. Four bits of data from two sources can be selected using the common Select and Enable inputs. The four outputs present the selected data in the true (noninverted) form.

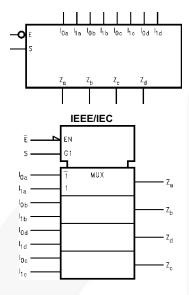
The LCX157 can also be used as a function generator.

The 74LCX157 is fabricated with advanced CMOS technology to achieve high speed operation while maintaining CMOS low power dissipation.

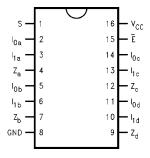
### **Ordering Information**

Part Number	Top Mark	Package	Packing Method
74LCX157M	LCX157	SOIC 16L	Rail
74LCX157MX	LCX157	SOIC 16L	Tape and Reel
74LCX157MTC	LCX157	TSSOP 16L	Rail
74LCX157MTCX	LCX157	TSSOP 16L	Tape and Reel

### **Logic Symbols**



### **Connection Diagram**



### **Pin Descriptions**

Pin Names Description	
I <sub>0a</sub> –I <sub>0d</sub>	Source 0 Data Inputs
I <sub>1a</sub> –I <sub>1d</sub>	Source 1 Data Inputs
Ē	Enable Input
S	Select Input
$Z_a$ – $Z_d$	Outputs

### **Functional Description**

The LCX157 is a quad 2-input multiplexer. It selects four bits of data from two sources under the control of a common Select input (S). The Enable input ( $\overline{E}$ ) is active-LOW. When  $\overline{E}$  is HIGH, all of the outputs (Z) are forced LOW regardless of all other inputs. The LCX157 is the logic implementation of a 4-pole, 2-position switch where the position of the switch is determined by the logic levels supplied to the Select input. The logic equations for the outputs are shown below:

$$Z_{a} = \overline{E} \cdot (I_{1a} \cdot S + I_{0a} \cdot \overline{S})$$

$$Z_{b} = \overline{E} \cdot (I_{1b} \cdot S + I_{0b} \cdot \overline{S})$$

$$Z_{c} = \overline{E} \cdot (I_{1c} \cdot S + I_{0c} \cdot \overline{S})$$

$$Z_{d} = \overline{E} \cdot (I_{1d} \cdot S + I_{0d} \cdot \overline{S})$$

A common use of the LCX157 is the moving of data from two groups of registers to four common output busses. The particular register from which the data comes is determined by the state of the Select input. A less obvious use is as a function generator. The LCX157 can generate any four of the sixteen different functions of two variables with one variable common. This is useful for implementing gating functions.

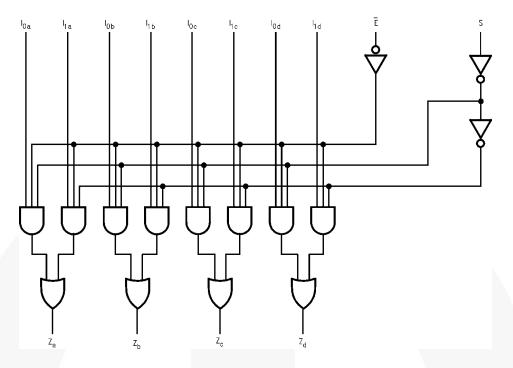
### **Truth Table**

	Inputs			Outputs
Ē	s	I <sub>0</sub>	I <sub>1</sub>	Z
Н	Х	Х	Х	L
L	Н	Х	L	L
L	Н	X	Н	Н
L	L	L	Х	L
L	L	Н	Х	Н

H = HIGH Voltage Level L = LOW Voltage Level

X = Immaterial

### Logic Diagram<sup>(1)</sup>



#### Note:

1. Please note that this diagram is provided only for the understanding of logic operations and should not be used to estimate propagation delays.

### Absolute Maximum Ratings(2)

Stresses exceeding the absolute maximum ratings may damage the device. The device may not function or be operable above the recommended operating conditions and stressing the parts to these levels is not recommended. In addition, extended exposure to stresses above the recommended operating conditions may affect device reliability. The absolute maximum ratings are stress ratings only.

Symbol	Parameter	Value	Conditions	Unit
V <sub>CC</sub>	Supply Voltage	-0.5 to +7.0		V
V <sub>I</sub>	DC Input Voltage	-0.5 to +7.0		V
Vo	DC Output Voltage	-0.5 to V <sub>CC</sub> +0.5	Output in HIGH or LOW State <sup>(3)</sup>	V
I <sub>IK</sub>	DC Input Diode Current	-50	V <sub>I</sub> < GND	mA
1 2	DC Output Diode Current	-50	V <sub>O</sub> < GND	mA
I <sub>OK</sub>	DC Output Diode Current	+50	$V_O > V_{CC}$	ША
Io	DC Output Source/Sink Current	±50		mA
I <sub>cc</sub>	DC Supply Current per Supply Pin	±100		mA
I <sub>GND</sub>	DC Ground Current per Ground Pin	±100		mA
T <sub>STG</sub>	Storage Temperature	-65 to +150		°C

#### Notes:

- 2. The Absolute Maximum Ratings are those values beyond which the safety of the device cannot be guaranteed. The device should not be operated at these limits. The parametric values defined in the Electrical Characteristics tables are not guaranteed at the Absolute Maximum Ratings. The "Recommended Operating Conditions" table will define the conditions for actual device operation.
- 3. IO Absolute Maximum Rating must be observed.

### **Recommended Operating Conditions**(4)

The Recommended Operating Conditions table defines the conditions for actual device operation. Recommended operating conditions are specified to ensure optimal performance to the datasheet specifications. Fairchild does not recommend exceeding them or designing to absolute maximum ratings.

Symbol	Parameter	Min.	Max.	Unit	
V <sub>CC</sub>	Supply Voltage	Operating	2.0	3.6	V
V <sub>IN</sub>	Input Voltage		0	5.5	V
V <sub>OUT</sub>	Output Voltage	HIGH or LOW State	0	V <sub>CC</sub>	V
		$V_{CC} = 3.0 \text{ V} - 3.6 \text{ V}$		±24	
I <sub>OH</sub> /I <sub>OL</sub>	Output Current	$V_{CC} = 2.7 \text{ V} - 3.0 \text{ V}$		±12	mA
		$V_{CC} = 2.3 \text{ V} - 2.7 \text{ V}$		±8	
T <sub>A</sub>	Free-Air Operating Temperature		-40	85	°C
Δt/ΔV	Input Edge Rate, $V_{IN} = 0.8 \text{ V} - 2.0 \text{ V}$ , $V_{CC} = 3.0 \text{ V}$		0	10	ns/V

#### Note:

4. Unused inputs must be held HIGH or LOW. They may not float.

#### **DC Electrical Characteristics**

Symbol	Parameter	Conditions	V (V)	$T_A = -40 \text{ to } +85^{\circ}\text{C}$		Unit	
Symbol	Parameter	Conditions	V <sub>CC</sub> (V)	Min.	Max.	Oilit	
V	1110111		2.3 - 2.7	1.7		V	
V <sub>IH</sub>	HIGH Level Input Voltage		2.7 - 3.6	2.0		_ v	
V	LOW Level level Veltage		2.3 - 2.7	1	0.7	V	
V <sub>IL</sub>	LOW Level Input Voltage		2.7 - 3.6		8.0	V	
		I <sub>OH</sub> = -100 μA	2.3 - 3.6	V <sub>CC</sub> - 0.2			
		$I_{OH} = -8 \text{ mA}$	2.3	1.8			
$V_{OH}$	V <sub>OH</sub> HIGH Level Output Voltage	I <sub>OH</sub> = -12 mA	2.7	2.2		V	
		I <sub>OH</sub> = -18 mA	3.0	2.4			
				$I_{OH} = -24 \text{ mA}$ 3.0	3.0	2.2	
		I <sub>OL</sub> = 100 μA	2.3 - 3.6		0.2		
		I <sub>OL</sub> = 8 mA	2.3		0.6		
V <sub>OL</sub>	LOW Level Output Voltage	I <sub>OL</sub> = 12 mA	2.7		0.4	V	
		I <sub>OL</sub> = 16 mA	3.0		0.4		
		I <sub>OL</sub> = 24 mA	3.0		0.55		
I <sub>I</sub>	Input Leakage Current	$0 \le V_1 \le 5.5 \text{ V}$	2.3 - 3.6		±5.0	μΑ	
I <sub>OFF</sub>	Power-Off Leakage Current	$V_I$ or $V_O = 5.5 \text{ V}$	0		10	μΑ	
1		$V_I = V_{CC}$ or GND	2.3 - 3.6		10		
I <sub>CC</sub> Qu	Quiescent Supply Current	$3.6 \text{ V} \le \text{V}_{\text{I}} \le 5.5 \text{ V}$	2.3 - 3.6		±10	μΑ	
Δl <sub>CC</sub>	Increase in I <sub>CC</sub> per Input	V <sub>IH</sub> = V <sub>CC</sub> - 0.6 V	2.3 - 3.6		500	μΑ	

#### **AC Electrical Characteristics**

		$T_A = -40 \text{ to } +85^{\circ}\text{C}, R_L = 500 \Omega$						
Symbol	Parameter	$V_{CC} = 3.3 \text{ V} \pm 0.3 \text{ V}$ $C_L = 50 \text{ pF}$		V <sub>CC</sub> = 2.7 V C <sub>L</sub> = 50 pF		$V_{CC} = 2.5 \text{ V} \pm 0.2 \text{ V}$ $C_L = 30 \text{ pF}$		Unit
Symbol	Farameter							
		Min.	Max.	Min.	Max.	Min.	Max.	
t <sub>PHL</sub>	Propagation Delay	1.5	7.0	1.5	8.0	1.5	8.4	ns
t <sub>PLH</sub>	S -> Z <sub>n</sub>	1.5	7.0	1.5	8.0	1.5	8.4	113
t <sub>PHL</sub>	Propagation Delay	1.5	7.0	1.5	8.0	1.5	8.4	ns
t <sub>PLH</sub>	$\overline{E} \rightarrow Z_n$	1.5	7.0	1.5	8.0	1.5	8.4	115
t <sub>PHL</sub>	Propagation Delay	1.5	5.8	1.5	6.3	1.5	7.0	ns
t <sub>PLH</sub>	$I_n \rightarrow Z_n$	1.5	5.8	1.5	6.3	1.5	7.0	115
t <sub>OSHL</sub>	(5)		1.0					nc
t <sub>OSLH</sub>	Output to Output Skew <sup>(5)</sup>		1.0					ns

#### Note:

5. Skew is defined as the absolute value of the difference between the actual propagation delay for any two separate outputs of the same device. The specification applies to any outputs switching in the same direction, either HIGH-to-LOW ( $t_{OSHL}$ ) or LOW-to-HIGH ( $t_{OSLH}$ ). Parameter guaranteed by design.

## **Dynamic Switching Characteristics**

Symbol	Parameter	Conditions	V (\( \)	T <sub>A</sub> = 25°C	Unit
Symbol Parameter		Conditions	V <sub>CC</sub> (V)	Typical	Onit
V	Quiet Output Dynamic Peak V <sub>OL</sub>	$C_L = 50 \text{ pF}, V_{IH} = 3.3 \text{ V}, V_{IL} = 0 \text{ V}$	3.3	0.8	V
V <sub>OLP</sub>	Quiet Output Dynamic Peak V <sub>OL</sub>	$C_L = 30 \text{ pF}, V_{IH} = 2.5 \text{ V}, V_{IL} = 0 \text{ V}$	2.5	0.6	V
V	Quiet Output Dynamic Valley V <sub>OL</sub>	$C_L = 50 \text{ pF}, V_{IH} = 3.3 \text{ V}, V_{IL} = 0 \text{ V}$	3.3	-0.8	V
V <sub>OLV</sub>	Quiet Output Dynamic valley V <sub>OL</sub>	$C_L = 30 \text{ pF}, V_{IH} = 2.5 \text{ V}, V_{IL} = 0 \text{ V}$	2.5	-0.6	V

## Capacitance

Symbol	Parameter	Conditions	Typical	Unit
C <sub>IN</sub>	Input Capacitance	$V_{CC}$ = Open, $V_I$ = 0 V or $V_{CC}$	7	pF
C <sub>OUT</sub>	Output Capacitance	$V_{CC} = 3.3 \text{ V}, V_{I} = 0 \text{ V or } V_{CC}$	8	pF
C <sub>PD</sub>	Power Dissipation Capacitance	$V_{CC}$ = 3.3 V, $V_{I}$ = 0 V or $V_{CC}$ , f = 10 MHz	25	pF

### AC Loading and Waveforms Generic for LCX Family

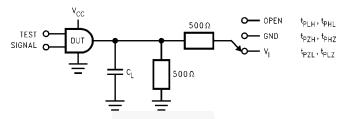
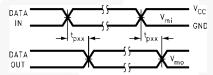
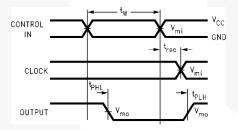


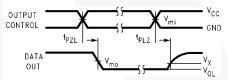
Figure 1. AC Test Circuit (C<sub>L</sub> includes probe and jig capacitance)

Test	Switch
t <sub>PLH</sub> , t <sub>PHL</sub>	Open
t <sub>PZL</sub> , t <sub>PLZ</sub>	6V at $V_{CC}$ = 3.3 $\pm$ 0.3V $V_{CC}$ x 2 at $V_{CC}$ = 2.5 $\pm$ 0.2V
t <sub>PZH</sub> , t <sub>PHZ</sub>	GND

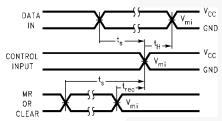


#### **Waveform for Inverting and Non-Inverting Functions**



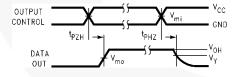


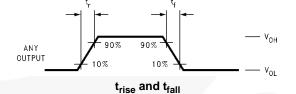
3-STATE Output Low Enable and Disable Times for Logic



Propagation Delay. Pulse Width and t<sub>rec</sub> Waveforms

Setup Time, Hold Time and Recovery Time for Logic



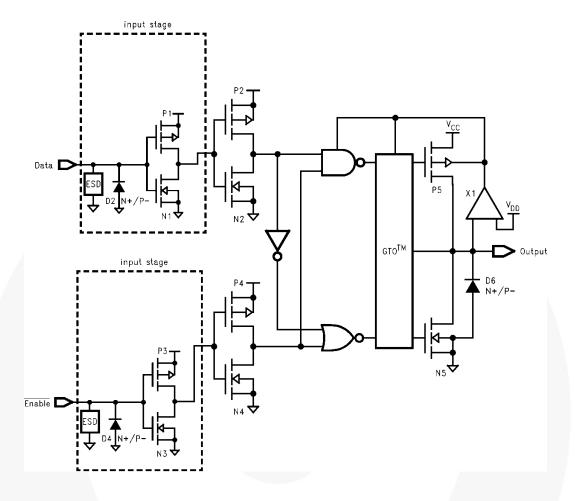


3-STATE Output High Enable and Disable Times for Logic

Figure 2. Waveforms (Input Characteristics; f = 1 MHz,  $t_r = t_f = 3$  ns)

Symbol		V <sub>CC</sub>	
Syllibol	$\textbf{3.3V} \pm \textbf{0.3V}$	2.7V	$\textbf{2.5V} \pm \textbf{0.2V}$
$V_{mi}$	1.5V	1.5V	V <sub>CC</sub> /2
$V_{mo}$	1.5V	1.5V	V <sub>CC</sub> /2
V <sub>x</sub>	V <sub>OL</sub> + 0.3V	V <sub>OL</sub> + 0.3V	V <sub>OL</sub> + 0.15V
V <sub>y</sub>	V <sub>OH</sub> – 0.3V	V <sub>OH</sub> – 0.3V	V <sub>OH</sub> – 0.15V

## Schematic Diagram Generic for LCX Family



## **Physical Dimensions** 10.00 9.80 8.89 В 4.00 3.80 6.00 5.6 **PIN ONE INDICATOR** 1.27 (0.30)**⊕** 0.25 **M** C B A LAND PATTERN RECOMMENDATION 1.75 MAX SEE DETAIL A 1.50 1.25 0.25 \_0.25 0.19 0.50 X 45° NOTES: UNLESS OTHERWISE SPECIFIED (R0.10) A) THIS PACKAGE CONFORMS TO JEDEC MS-012, VARIATION AC, ISSUE C. B) ALL DIMENSIONS ARE IN MILLIMETERS. C) DIMENSIONS ARE EXCLUSIVE OF BURRS, MOLD FLASH AND TIE BAR PROTRUSIONS D) CONFORMS TO ASME Y14.5M-1994 E) LANDPATTERN STANDARD: SOIC127P600X175-16AM F) DRAWING FILE NAME: M16AREV12. **GAGE PLANE** (R0.10) 0.36 **SEATING PLANE** 0.90 0.50 (1.04) -**DETAIL A**

Figure 3. 16-LEAD, SOIC, JEDEC MS-012, 0.150 INCH, NARROW BODY

### Α 5.00±0.10 4.55 5.90 4.45 7.35 B 6.4 0.65 4.4±0.1 3.2 O.2 CBA ALL LEAD TIPS 5.00 PIN #1 IDENT. LAND PATTERN RECOMMENDATION (F) 0.11 SEE DETAIL A ALL LEAD TIPS 1.1 MAX (0.90)◯ 0.1 C -C-0.10±0.05 0.65 0.19 - 0.30 TOP AND BOTTOM **♦ 0.10** A B C C S GAGE PLANE NOTES: 0.25 A. CONFORMS TO JEDEC REGISTRATION MO-153, VARIATION AB, B. DIMENSIONS ARE IN MILLIMETERS C. DIMENSIONS ARE EXCLUSIVE OF BURRS, MOLD FLASH, AND TIE BAR EXTRUSIONS 0.6±0.1 SEATING PLANE D. DIMENSIONING AND TOLERANCES PER ANSI Y14.5M, 1994 E. DRAWING FILE NAME: MTC16REV4 **DETAIL** A F. LAND PATTERN RECOMMENDATION PER IPC7351 - ID# TSOP65P640X110-16N

Figure 4. 16-LEAD, TSSOP, JEDEC MO-153, 4.4 MM WIDE

MTC16rev4

Physical Dimensions (Continued)





#### TRADEMARKS

The following includes registered and unregistered trademarks and service marks, owned by Fairchild Semiconductor and/or its global subsidiaries, and is not intended to be an exhaustive list of all such trademarks.

AccuPower™ F-PFS™ AttitudeEngine™ FRFET® Awinda® AX-CAP®\* Global Power Resource SM GreenBridge™

BitSiC™ Green FPS™ Build it Now™ Green FPS™ e-Series™

CorePLUS™ Gmax™ CorePOWER™ GTO™  $CROSSVOLT^{\text{\tiny TM}}$ IntelliMAX™ CTL™ ISOPI ANAR™

Current Transfer Logic™ Making Small Speakers Sound Louder **DEUXPEED**®

and Better™ Dual Cool™ MegaBuck™ EcoSPARK® MICROCOUPLER™ EfficientMax™ MicroFET™ ESBC™ MicroPak™

MicroPak2™ MillerDrive™ Fairchild® MotionMax™ Fairchild Semiconductor® MotionGrid® FACT Quiet Series™ MTi<sup>®</sup> FACT® FAST® MTx® MVN® FastvCore™ mWSaver® FETBench™ OptoHiT™

OPTOPLANAR®

Power Supply WebDesigner™

PowerTrench<sup>©</sup> PowerXS™

Programmable Active Droop™

QFĔT QS™ Quiet Series™ RapidConfigure™

Saving our world, 1mW/W/kW at a time™

SignalWise™ SmartMax™ SMART START™

Solutions for Your Success™

SPM<sup>®</sup> STEALTH™ SuperFET® SuperSOT™-3 SuperSOT™-6 SuperSOT™-8 SupreMOS<sup>®</sup> SyncFET™ Sync-Lock™

TinyBoost<sup>®</sup> TinyBuck® TinyCalc™ TinyLogic<sup>®</sup> TINYOPTO™ TinyPower™ TinyPWM™ TinvWire™ TranSiC™

SYSTEM GENERAL®\*

TriFault Detect™ TRUECURRENT®\* μSerDes™

UHC<sup>®</sup> Ultra FRFET™ UniFET™  $VCX^{TM}$ VisualMax™ VoltagePlus™ XSTM Xsens™

仙童™

\* Trademarks of System General Corporation, used under license by Fairchild Semiconductor.

OPTOLOGIC®

**FPSTM** 

FAIRCHILD SEMICONDUCTOR RESERVES THE RIGHT TO MAKE CHANGES WITHOUT FURTHER NOTICE TO ANY PRODUCTS HEREIN TO IMPROVE RELIABILITY, FUNCTION, OR DESIGN. TO OBTAIN THE LATEST, MOST UP-TO-DATE DATASHEET AND PRODUCT INFORMATION, VISIT OUR WEBSITE DSEMI.COM. FAIRCHILD DOES NOT ASSUME ANY LIABILITY ARISING OUT OF THE APPLICATION OR USE OF ANY PRODUCT OR CIRCUIT DESCRIBED HEREIN; NEITHER DOES IT CONVEY ANY LICENSE UNDER ITS PATENT RIGHTS, NOR THE RIGHTS OF OTHERS. THESE SPECIFICATIONS DO NOT EXPAND THE TERMS OF FAIRCHILD'S WORLDWIDE TERMS AND CONDITIONS, SPECIFICALLY THE WARRANTY THEREIN, WHICH COVERS THESE PRODUCTS.

#### LIFE SUPPORT POLICY

FAIRCHILD'S PRODUCTS ARE NOT AUTHORIZED FOR USE AS CRITICAL COMPONENTS IN LIFE SUPPORT DEVICES OR SYSTEMS WITHOUT THE EXPRESS WRITTEN APPROVAL OF FAIRCHILD SEMICONDUCTOR CORPORATION.

- 1. Life support devices or systems are devices or systems which, (a) are intended for surgical implant into the body or (b) support or sustain life, and (c) whose failure to perform when properly used in accordance with instructions for use provided in the labeling, can be reasonably expected to result in a significant injury of the user.
- 2. A critical component in any component of a life support, device, or system whose failure to perform can be reasonably expected to cause the failure of the life support device or system, or to affect its safety or effectiveness

#### ANTI-COUNTERFEITING POLICY

Fairchild Semiconductor Corporation's Anti-Counterfeiting Policy. Fairchild's Anti-Counterfeiting Policy is also stated on our external website, www.fairchildsemi.com, under Sales Support.

Counterfeiting of semiconductor parts is a growing problem in the industry. All manufacturers of semiconductor products are experiencing counterfeiting of their parts. Customers who inadvertently purchase counterfeit parts experience many problems such as loss of brand reputation, substandard performance, failed applications, and increased cost of production and manufacturing delays. Fairchild is taking strong measures to protect ourselves and our customers from the proliferation of counterfeit parts. Fairchild strongly encourages customers to purchase Fairchild parts either directly from Fairchild or from Authorized Fairchild Distributors who are listed by country on our web page cited above. Products customers buy either from Fairchild directly or from Authorized Fairchild Distributors are genuine parts, have full traceability, meet Fairchild's quality standards for handling and storage and provide access to Fairchild's full range of up-to-date technical and product information. Fairchild and our Authorized Distributors will stand behind all warranties and will appropriately address any warranty issues that may arise. Fairchild will not provide any warranty coverage or other assistance for parts bought from Unauthorized Sources. Fairchild is committed to combat this global problem and encourage our customers to do their part in stopping this practice by buying direct or from authorized distributors

#### PRODUCT STATUS DEFINITIONS

Definition of Terms	ennition of Terms			
Datasheet Identification	Product Status	Definition		
Advance Information	Formative / In Design	Datasheet contains the design specifications for product development. Specifications may change in any manner without notice.		
Preliminary	First Production	Datasheet contains preliminary data; supplementary data will be published at a later date. Fairchild Semiconductor reserves the right to make changes at any time without notice to improve design.		
No Identification Needed	Full Production	Datasheet contains final specifications. Fairchild Semiconductor reserves the right to make changes at any time without notice to improve the design.		
Obsolete	Not In Production	Datasheet contains specifications on a product that is discontinued by Fairchild Semiconductor. The datasheet is for reference information only.		

Rev 174

# **Mouser Electronics**

**Authorized Distributor** 

Click to View Pricing, Inventory, Delivery & Lifecycle Information:

Fairchild Semiconductor:

74LCX157M 74LCX157MTCX 74LCX157MTC 74LCX157MX